

CH20M22 B SIM BK/OR 2010

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image



Superior efficiency, flexibility and design - the "standard tailor-made fit"

When selecting a housing design, flexibility is a key factor. Other important criteria are: scalability, customised design, innovative functionality and cost efficiency. You need a choice which offers the maximum performance with the minimum overhead.

The CH20M22 modular electronics housing is the standard format from amongst the different housing widths. It has the optimal width for most typical electronics applications.

The entire system is characterized by excellence: outstanding scalability and flexibility, a high security level, innovative application functionality and a variety of practical details.

- **Quicker installation** with features such as "Wire ready" the universal multi-tool screw head
- **User-friendly operations:** with clear and permanent labelling and extra marking possibilities, integrated release clip or transparent cover
- **Maximum interference immunity** with ESD-compliant construction featuring deeply overlapping module joint edges made from high-performance plastic
- **High operational reliability** with the unique Auto-Set coding system and featuring double-sided touch protection on the pin header and socket blocks

CH20M - a compact name for the most flexible system available on the market. It doesn't just stand for "Component Housing IP20 Modular".

CH20M also stands for efficiency and innovation throughout design, production and use.

General ordering data

Version	Mounting rail housing, OMNIMATE Housing - series CH20M black, Side element, connection preparation micro-SIM card (3FF), Width: 22.5 mm
Order No.	2743520000
Type	CH20M22 B SIM BK/OR 2010
GTIN (EAN)	4064675313168
Qty.	10 pc(s).

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Technical data

Dimensions and weights

Depth	107.4 mm	Depth (inches)	4.228 inch
Height	109.3 mm	Height (inches)	4.303 inch
Width	22.5 mm	Width (inches)	0.886 inch
Net weight	40 g		

Temperatures

Operating temperature range	-40 °C...120 °C	Humidity	5 - 93% rel. humidity, Tu = 40°C, no condensation
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Material data

Comparative Tracking Index (CTI)	600 ≤ CTI	Insulating material	PA 66 GF 30
Insulating material group	I	UL 94 flammability rating	V-0

General data

Colour	black	Colour chart (similar)	RAL 9011
Encapsulation option	No	Protection degree	IP20 in installed state
Rail	TS 35		

Assembly properties

Number of slots for female connectors of the mounted assembly, max.	6	Number of PCBs, max.	1
Number of connection levels, max.	3	Number of poles, max.	24
Height of components on the PCB, max.	16.1 mm	Type of assembly of the PCB	double-sided

Mechanical tests

According to Standard	DIN EN 61373:1999 (shock and vibration)		
Test conditions	five housings installed in a row, 200g additional weight on the PCB		
Proved axles	X, Y, Z		
Shock test	General test advices	All mechanical tests were tested on exemplary setup, or in view of depending regulation. The specified results do not replace approval relevant tests. They are just orientation values.	
	Test category	1	
	Number of shocks per axle	3 in positive and negative direction	
	Shock duration	30 ms	
	Acceleration horizontal	30 m/s ²	
	Acceleration vertical	30 m/s ²	
Vibration test	Acceleration longitudinal	50 m/s ²	
	Test category	1B	
	Test duration	5 hours per axle	
	Effective acceleration	7.9 m/s ²	

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Thermal tests

Thermal tests	General test advices	All thermal tests were tested on exemplary set-up, or in view of depending regulation. The specified results do not replace approval relevant tests. They are just orientation values.
	Test conditions	three housings installed in a row - no spacing
	Test axles	horizontal
	Ambient temperature	70 °C
	Power dissipation, max.	1.9 W
	Ambient temperature	60 °C
	Power dissipation, max.	2.35 W
	Ambient temperature	40 °C
	Power dissipation, max.	3.4 W
	Ambient temperature	20 °C
Power dissipation, max.	4.5 W	

Component properties

Color of clip-on foot	orange	Cut out in clip-on foot area as preparation for	Micro SIM card (3FF)
Number of connection levels, max.	3		

Design - IN requirements

PCB thickness	1.6 mm	Tolerance for the PCB shape	±0.1 mm
Tolerance of circuit board thickness	±0.15 mm		

Individualization options

Alternative colours	More on request	Customer specific labelling possible	Yes
Customer specific order process	See guideline under downloads	Processing possibilities	Laser processing

Classifications

ETIM 8.0	EC001031	ETIM 9.0	EC001031
ECLASS 11.0	27-18-27-92	ECLASS 12.0	27-18-27-92
ECLASS 13.0	27-19-06-01		

Environmental Product Compliance

REACH SVHC	/
RoHS Compliance Status	Compliant without exemption

Important note

Product information	Circuit board contour, restricted zones, and other information for the design in of the circuit board can be found in the category connection technology under the corresponding male headers in the downloads.
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Approvals

ROHS	Conform
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Technical data

Downloads

Engineering Data	CAD data – Pin_header_pin_length_CH20M_A_OV_PCB-SHL_70315 CAD data – STEP
Technical Documentation	PCB_position_50881_LP-POSITION_22MM
User Documentation	Guideline customerspecific housings Guideline kundenspezifische Gehäuse
Catalogues	Catalogues in PDF-format

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Drawings

Product image



Product benefits



Base element including SIM cut-out

Dimensioned drawing

